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Bill of Materials

TI DESIGNS Part #: PMP5411

Literature #

DESIGNATOR	QUANTITY	VALUE	DESCRIPTION	MANUFACTURER	PART NUMBER	SIZE
C1	1	100uF	Capacitor, Electrolytic, 400V, 20%	Nichicon	LLS2G101MELY	20x30
C10	1	1500pF	CAP, CERM DISC Y1, 250Vac, 20%	Panasonic	ECKDNA152ME	.500 X .310
C11	1	DNP	Do Not Populate	N/A	N/A	0603
C12	1	0.022uF	Capacitor, Ceramic, 50V, X7R, 10%	TDK	C1608X7R1H223K	0603
C14	1	56uF	Capacitor, Aluminum Electrolytic, 35V	Rubycon	35V ZL 56uF 6.3 X 11	0.248 inch
C16	1	100pF	Capacitor, Ceramic, 50V, X7R, 10%	TDK	C1608X7R1H101K	0603
C17, C18, C27, C28,						
C37	5	10uF	Capacitor, Ceramic, 16V, X7R, 15%	STD	STD	1206
C19, C21, C29, C31,						
C38	5	1uF	Capacitor, Ceramic, 16V, X7R, 20%	Std	Std	0603
C2	1	0.01uF	Capacitor, Polyester Film, 400V, 10%	Panasonic	ECQ-E4103KB	0.311 x 0.213 inch
C24, C26, C34, C36,						
C41	5	22uF	Capacitor, Ceramic, 6.3V, X5R, 15%	Std	Std	0805
C3	1	0.22 uF	Capacitor, Film, 250VAC, 20%	Panasonic	STD	0.689 x 0.217
C4, C5, C6, C7	4	22uF	Capacitor, Ceramic, 16V, X7R, 20%	TDK	C3225X7R1C226MT	1210
C8	1	470uF	Capacitor, Aluminum Electrolytic, 16V	Rubycon	16V ZL 470uF 10 X 12.5	0.315 inch
C9, C13, C15, C20,						
C22, C23, C25, C30,						
C32, C33, C35, C39,						
C40	13	0.1uF	Capacitor, Ceramic, 50V, X7R, 10%	TDK	C1608X7R1H104K	0603
D1	1	DF04S	Bridge Rectifier, 400V, 1A, SMD	Diodes	DF04S	DF-S
D100	1	18V	Diode, Zener, 18V, 3W	On Semi	1SMB5931BT3	SMB
D2	1	US1K-13	Diode, Rectifier, 1A, 800V	Diodes Inc	US1K-13	SMA
D3	1	SBR2060CT	Diode, Dual Schottky, 20A, 60V	Diodes Inc.	SBR2060CT	TO-220
D4	1	MMSD914	Diode, Switching, 100-V, 200-mA, 225-mW	On Semi	MMSD914T1	SOD-123
D5	1	MBR0520L	Diode, Schottky, 0.5A, 20V	Fairchild	MBR0520L	SOD-123
F1	1	2A	Fuse, TR5 Series, 2A, 250V	Wickmann	3701200041	0.335
HS1, HS2	2	576802B00000G	Heatsink, TO-220 Vertical-mount,	Thermalloy	576802B00000G	0.500 x 0.570 inch
J1, J2, J3, J4, J7, J8,						
J11	7	ED1514	Terminal Block, 2-pin, 6-A, 3.5mm	OST	ED1514	0.27 x 0.25
J5, J6, J9, J10, J12	5	PTC36SAAN	Header, Male 2-pin, 100mil spacing, (36-pin strip)	Sullins	PTC36SAAN	0.100 inch x 2
JP1, JP2, JP3	3	923345-02-C	Jumper, 0.200 inch length, PVC Insulation, AWG 22,	3M	923345-02-C	0.035 inch Dia.
L1	1	1.3mH	Inductor, 0.7A, 0.5ohm	GCI	UU9.8H-132LF	0.433 x 0.670 inch

DESIGNATOR	QUANTITY	VALUE	DESCRIPTION	MANUFACTURER	PART NUMBER	SIZE
L2	1	2.2uH	Inductor, Power, 5A	Coilcraft	RFB0807-2R2L	0.350 x 0.300 inch
L3, L4, L5, L6, L7	5	2.2uH	Inductor, Shielded Drum Core, 4A, 20milliohms	Wurth	7447789002	0.300 sq"
Q1	1	SPP06N80C3	Trans, Nchan, 800V, 6A, 900 millohm	Infineon	SPP06N80C3	TO-220AB
R1, R2	2	249k	Resistor, 1W, 5%	STD	STD	2512
R10	1	2k	Resistor, Chip, 1/16W, 1%	Std	Std	0603
R100	1	51.1	Resistor,1/4 watt, 5%	Std	Std	1206
R101	1	200	Resistor,1/4 watt, 5%	Std	Std	1206
R11	1	49.9k	Resistor, Chip, 1/16W, 1%	Std	Std	0603
R12	1	60.4k	Resistor, Chip, 1/16W, 1%	Std	Std	0603
R13, R16, R17, R18,						
R23, R24, R27, R28,						
R33, R34, R37, R40	12	100k	Resistor, Chip, 1/16W, 1%	Std	Std	0603
R14	1	2.61k	Resistor, Chip, 1/16W, 1%	Std	Std	0603
R15	1	20k	Resistor, Chip, 1/16W, 1%	Std	Std	0603
R20	1	34.0k	Resistor, Chip, 1/16W, 1%	Std	Std	0603
R22	1	54.9k	Resistor, Chip, 1/16W, 1%	Std	Std	0603
R3, R4	2	3MEG	Resistor,1/4 watt, 5%	Std	Std	1206
R30	1	23.2k	Resistor, Chip, 1/16W, 1%	Std	Std	0603
R32	1	13.7k	Resistor, Chip, 1/16W, 1%	Std	Std	0603
R39	1	5.62k	Resistor, Chip, 1/16W, 1%	Std	Std	0603
R42	1	0	Resistor, Chip, 1/16W, 1%	Std	Std	0805
R43	1	0	Resistor, Chip, 1/16W, 1%	Std	Std	0603
R5	1	0.22	Resistor, 1/4W, 5%	Std	Std	1210
R6	1	169k	Resistor, Chip, 1/16W, 1%	Std	Std	0603
R8	1	4.99k	Resistor, Chip, 1/16W, 1%	Std	Std	0603
R9, R19, R21, R29,						
R31, R38	6	10k	Resistor, Chip, 1/16W, 1%	Std	Std	0603
RT1	1	4.7 Ohms	Thermistor, NTC, 4.7 Ohms, 3-A	Epcos	B57153S0479M000	0.590 x 0.276
T1	1	290 uH	Xfmr, Flyback, 12%	GCI	G104046LF	26.00 x 29.00 mm
TP1, TP2, TP3, TP5,						
TP7, TP8, TP9, TP10,						
TP15, TP16, TP17,						
TP18, TP23, TP24,						
TP27	15	5000	Test Point, Red, Thru Hole Color Keyed	Keystone	5000	0.100 x 0.100 inch
TP4, TP6, TP13,						
TP14, TP21, TP22,						
TP26	7	5001	Test Point, Black, Thru Hole Color Keyed	Keystone	5001	0.100 x 0.100 inch
U1	1	UCC28610D	IC, Flyback Green-Mode Controller	TI	UCC28610D	SO8
U2	1	H11A817A	IC, Optocoupler, 5300-V, 80-160% CTR	Fairchild	H11A817A	0.380 x 0.180 inch
U3	1	TL431AIDBZ	IC, Precision Adjustable Shunt Regulator	TI	TL431AIDBZ	SOT23-3
U4, U5, U6, U7, U8	5	TPS54325PWP	IC, 3-A Switcher W/ Integrated FET	TI	TPS54325PWP	HTSSOP-14

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